

Absolute Maximum Ratings(Note 1)

Voltage at Any Pin	-0.3V to $V_{CC} + 0.3V$
Operating Temperature Range	-55°C to +125°C
Storage Temperature Range	-65°C to +150°C
Power Dissipation	
Dual-In-Line	700 mW
Small Outline	500 mW
Operating V_{CC} Range	4.5V to 15V
Absolute Maximum V_{CC}	18V
$R_{EXT} \geq 80 V_{CC} (\Omega)$	
Lead Temperature (Soldering, 10 seconds)	260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics table provides conditions for actual device operation.

DC Electrical Characteristics

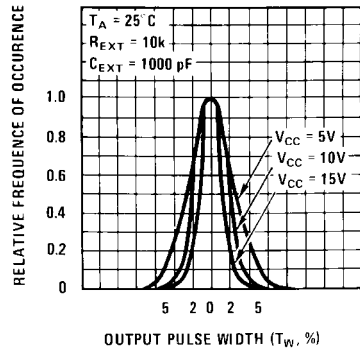
Max/min limits apply across temperature range, unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
CMOS to CMOS						
$V_{IN(1)}$	Logical "1" Input Voltage	$V_{CC} = 5V$ $V_{CC} = 10V$	3.5 8.0			V
$V_{IN(0)}$	Logical "0" Input Voltage	$V_{CC} = 5V$ $V_{CC} = 10V$			1.5 2.0	V
$V_{OUT(1)}$	Logical "1" Output Voltage	$V_{CC} = 5V, I_O = -10 \mu A$ $V_{CC} = 10V, I_O = -10 \mu A$	4.5 9.0			V
$V_{OUT(0)}$	Logical "0" Output Voltage	$V_{CC} = 5V, I_O = +10 \mu A$ $V_{CC} = 10V, I_O = +10 \mu A$			0.5 1	V
$I_{IN(1)}$	Logical "1" Input Current	$V_{CC} = 15V, V_{IN} = 15V$		0.005	1.0	μA
$I_{IN(0)}$	Logical "0" Input Current	$V_{CC} = 15V, V_{IN} = 0V$	-1.0	-0.005		μA
I_{CC}	Supply Current (Standby)	$V_{CC} = 15V, R_{EXT} = \infty$, Q1, Q2 = Logic "0" (Note 2)		0.05	300	μA
I_{CC}	Supply Current (During Output Pulse)	$V_{CC} = 15V, Q1 = \text{Logic "1"}$, $Q2 = \text{Logic "0"}$ (Figure 4) $V_{CC} = 5V, Q1 = \text{Logic "1"}$, $Q2 = \text{Logic "0"}$ (Figure 4)		15 2		mA mA
	Leakage Current at R/C _{EXT} Pin	$V_{CC} = 15V, V_{CEXT} = 5V$		0.01	3.0	μA
CMOS/LPTTL Interface						
$V_{IN(1)}$	Logical "1" Input Voltage	$V_{CC} = 4.75V$	$V_{CC} - 1.5$			V
$V_{IN(0)}$	Logical "0" Input Voltage	$V_{CC} = 4.75V$			0.8	V
$V_{OUT(1)}$	Logical "1" Output Voltage	$V_{CC} = 4.75V, I_O = -360 \mu A$	2.4			V
$V_{OUT(0)}$	Logical "0" Output Voltage	$V_{CC} = 4.75V, I_O = 360 \mu A$			0.4	V
Output Drive (See Family Characteristics Data Sheet) (Short Circuit Current)						
I_{SOURCE}	Output Source Current (P-Channel)	$V_{CC} = 5V$ $T_A = 25^\circ C, V_{OUT} = 0V$	-1.75			mA
I_{SOURCE}	Output Source Current (P-Channel)	$V_{CC} = 10V$ $T_A = 25^\circ C, V_{OUT} = 0V$	-8			mA
I_{SINK}	Output Sink Current (N-Channel)	$V_{CC} = 5V$ $T_A = 25^\circ C, V_{OUT} = V_{CC}$	1.75			mA
I_{SINK}	Output Sink Current (N-Channel)	$V_{CC} = 10V$ $T_A = 25^\circ C, V_{OUT} = V_{CC}$	8			mA

Note 2: In Standby (Q = Logic "0") the power dissipated equals the leakage current plus V_{CC}/R_{EXT} .

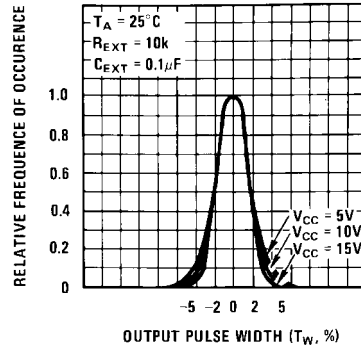
AC Electrical Characteristics (Note 3)						
$T_A = 25^\circ\text{C}$, $C_L = 50\text{ pF}$, unless otherwise noted						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
$t_{pd\ A, B}$	Propagation Delay from Trigger Input (A, B) to Output Q, \bar{Q}	$V_{CC} = 5V$		250	500	ns
		$V_{CC} = 10V$		120	250	
$t_{pd\ CL}$	Propagation Delay from Clear Input (CL) to Output Q, \bar{Q}	$V_{CC} = 5V$		250	500	ns
		$V_{CC} = 10V$		120	250	
t_S	Time Prior to Trigger Input (A, B) that Clear must be Set	$V_{CC} = 5V$	150	50		ns
		$V_{CC} = 10V$	60	20		
$t_{W(A, B)}$	Trigger Input (A, B) Pulse Width	$V_{CC} = 5V$	150	50		ns
		$V_{CC} = 10V$	70	30		
$t_{W(CL)}$	Clear Input (CL) Pulse Width	$V_{CC} = 5V$	150	50		ns
		$V_{CC} = 10V$	70	30		
$t_{W(OUT)}$	Q or \bar{Q} Output Pulse Width	$V_{CC} = 5V$, $R_{EXT} = 10k$, $C_{EXT} = 0\text{ pF}$		900		ns
		$V_{CC} = 10V$, $R_{EXT} = 10k$, $C_{EXT} = 0\text{ pF}$		350		ns
		$V_{CC} = 15V$, $R_{EXT} = 10k$, $C_{EXT} = 0\text{ pF}$		320		ns
		$V_{CC} = 5V$, $R_{EXT} = 10k$, $C_{EXT} = 1000\text{ pF}$ (Figure 1)	9.0	10.6	12.2	μs
		$V_{CC} = 10V$, $R_{EXT} = 10k$, $C_{EXT} = 1000\text{ pF}$ (Figure 1)	9.0	10	11	μs
		$V_{CC} = 15V$, $R_{EXT} = 10k$, $C_{EXT} = 1000\text{ pF}$ (Figure 1)	8.9	9.8	10.8	μs
		$V_{CC} = 5V$, $R_{EXT} = 10k$, $C_{EXT} = 0.1\ \mu\text{F}$ (Figure 3)	900	1020	1200	μs
		$V_{CC} = 10V$, $R_{EXT} = 10k$, $C_{EXT} = 0.1\ \mu\text{F}$ (Figure 3)	900	1000	1100	μs
		$V_{CC} = 15V$, $R_{EXT} = 10k$, $C_{EXT} = 0.1\ \mu\text{F}$ (Figure 3)	900	990	1100	μs
		R_{ON}	ON Resistance of Transistor between R/ C_{EXT} to C_{EXT}	$V_{CC} = 5V$ (Note 4)		50
$V_{CC} = 10V$ (Note 4)				25	65	
$V_{CC} = 15V$ (Note 4)				16.7	45	
	Output Duty Cycle	$R = 10k$, $C = 1000\text{ pF}$ $R = 10k$, $C = 0.1\ \mu\text{F}$ (Note 5)			90 90	%
C_{IN}	Input Capacitance	R/ C_{EXT} Input (Note 6)		15	25	pF
		Any Other Input (Note 6)		5		
<p>Note 3: AC Parameters are guaranteed by DC correlated testing.</p> <p>Note 4: See AN-138 for detailed explanation R_{ON}.</p> <p>Note 5: Maximum output duty cycle = $R_{EXT}/R_{EXT} + 1000$.</p> <p>Note 6: Capacitance is guaranteed by periodic testing.</p>						

Typical Performance Characteristics



0% Point pulse width:
 At VCC = 5V, TW = 10.6 μs
 At VCC = 10V, TW = 10 μs
 At VCC = 15V, TW = 9.8 μs
 Percentage of units within +4%:
 At VCC = 5V, 90% of units
 At VCC = 10V, 95% of units
 At VCC = 15V, 98% of units

FIGURE 1. Typical Distribution of Units for Output Pulse Width



0% Point pulse width:
 At VCC = 5V, TW = 1020 μs
 At VCC = 10V, TW = 1000 μs
 At VCC = 15V, TW = 982 μs
 Percentage of units within +4%:
 At VCC = 5V, 95% of units
 At VCC = 10V, 97% of units
 At VCC = 15V, 98% of units

FIGURE 3. Typical Distribution of Units for Output Pulse Width

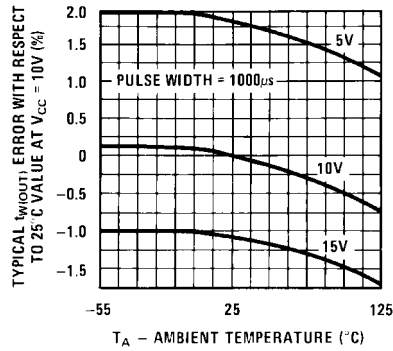


FIGURE 2. Typical Variation in Output Pulse Width vs Temperature

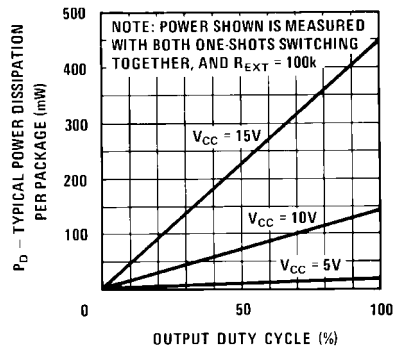
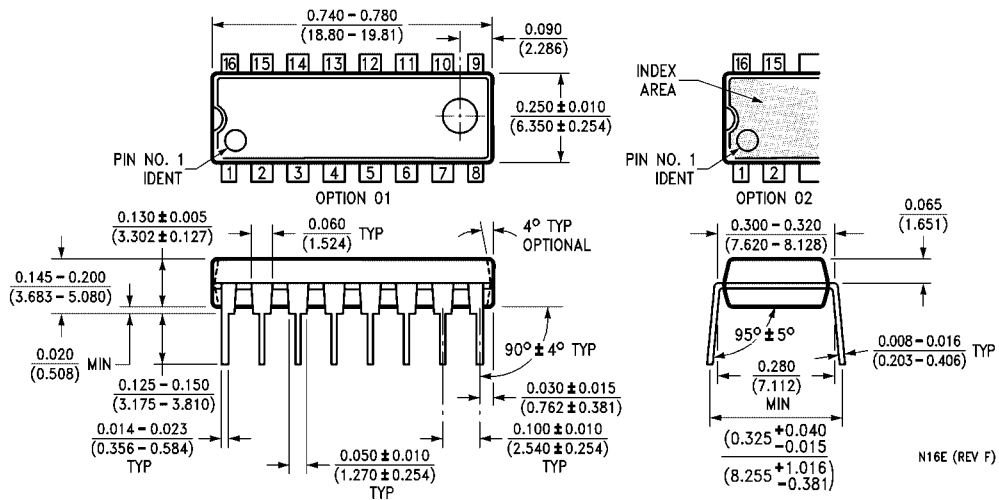


FIGURE 4. Typical Power Dissipation per Package

Physical Dimensions inches (millimeters) unless otherwise noted



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N16E

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